



## N-Channel 40-V (D-S), 175 °C MOSFET

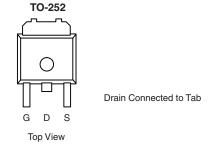
# PRODUCT SUMMARY $V_{(BR)DSS}(V)$ $r_{DS(on)}(Ω)$ $I_D(A)^c$ $Q_g(Typ)$ 40 0.009 at $V_{GS} = 10 \text{ V}$ 50 55

### **FEATURES**

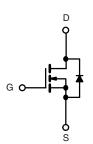
- TrenchFET® Power MOSFETS
- 175 °C Junction Temperature
- High Threshold Voltage At High Temperature







Ordering Information: SUD50N04-09H-E3 (Lead (Pb)-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A =$	25 °C, unless othe	rwise noted			
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	40	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	
Continuous Drain Current (T <sub>J</sub> = 175 °C)	T <sub>C</sub> = 25 °C	I-	50 <sup>c</sup>		
	T <sub>C</sub> = 100 °C	- I <sub>D</sub>	48 <sup>c</sup>	] A	
Pulsed Drain Current		I <sub>DM</sub> 100 I <sub>AS</sub> 35			
Avalanche Current					
Single Avalanche Energy <sup>a</sup>	L = 0.1 mH	E <sub>AS</sub>	61.25	mJ	
Power Dissipation	T <sub>C</sub> = 25 °C	P <sub>D</sub>	83.3	W	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS								
Parameter		Symbol	Typical Maximu		Unit			
Junction-to-Ambient <sup>b</sup>	t ≤ 10 sec	- R <sub>thJA</sub>	18	22	°C/W			
	Steady State		40	50				
Junction-to-Case		R <sub>thJC</sub>	1.5	1.8				

#### Notes:

- a. Duty cycle  $\leq$  1 %.
- b. Surface Mounted on 1" FR4 board.
- c. Based on maximum allowable Junction Temperature. Package limitation current is 50 A.

### SUD50N04-09H

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<b>SPECIFICATIONS</b> $T_J = 25$ Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Static	Symbol	Test conditions	IVIIII	Тур	IVIAA	Oilit
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA	40	1		
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	3.4		5.0	V
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	0.1		± 100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$			1	1171
		V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C			50	μΑ
	D00	V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 175 °C			150	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	V <sub>DS</sub> = 5 V, V <sub>GS</sub> = 10 V	50			Α
Drain-Source On-State Resistance <sup>a</sup>	2(0)	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A	0.0072		0.009	Ω
	r <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A, T <sub>J</sub> = 125 °C			0.014	
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 20 A, T <sub>J</sub> = 175 °C			0.018	1
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 15 A	20	57		S
Dynamic <sup>b</sup>						
Input Capacitance	C <sub>iss</sub>			3700		pF
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		340		
Reverse Transfer Capacitance	C <sub>rss</sub>			175		
Total Gate Charge <sup>c</sup>	Qg			55	85	nC
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 50 \text{ A}$		19		
Gate-Drain Charge <sup>c</sup>	Q <sub>qd</sub>			13		
Gate Resistance	R <sub>g</sub>			1.3		Ω
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			12	20	- ns
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD}$ = 20 V, $R_L$ = 0.4 $\Omega$ $I_D \cong$ 50 A, $V_{GEN}$ = 10 V, $R_q$ = 2.5 $\Omega$		20	30	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>			35	55	
Fall Time <sup>c</sup>	t <sub>f</sub>	<u>,</u>		11	20	
Source-Drain Diode Ratings and Cha	aracteristics	(T <sub>C</sub> = 25 °C) <sup>b</sup>		1		
Continuous Current	Is				50	
Pulsed Current	I <sub>SM</sub>				100	A
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	$I_F = 30 \text{ A}, V_{GS} = 0 \text{ V}$		0.90	1.50	V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 30 A, di/dt = 100 A/μs		30	45	ns

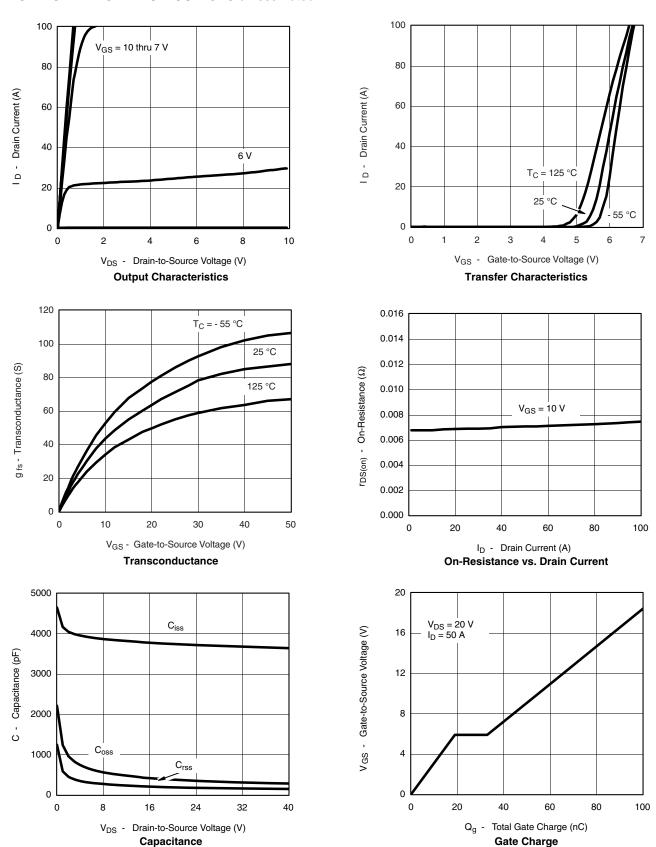
### Notes:

- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

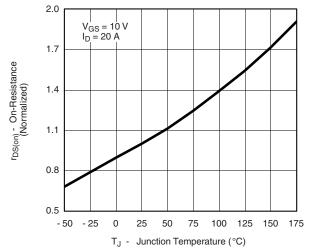


### TYPICAL CHARACTERISTICS 25 °C unless noted



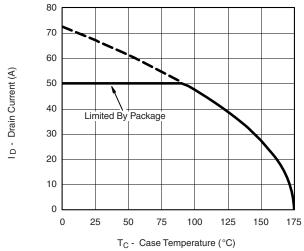
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### TYPICAL CHARACTERISTICS 25 °C unless noted

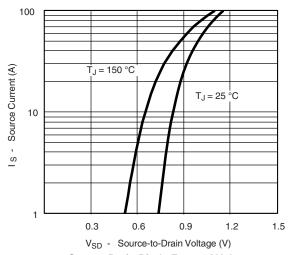


#### On-Resistance vs. Junction Temperature

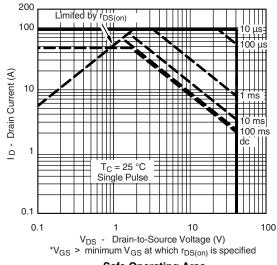
### THERMAL RATINGS



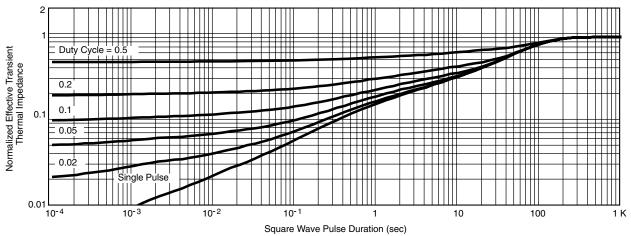
**Maximum Avalanche and Drain Current** vs. Case Temperature



Source-Drain Diode Forward Voltage



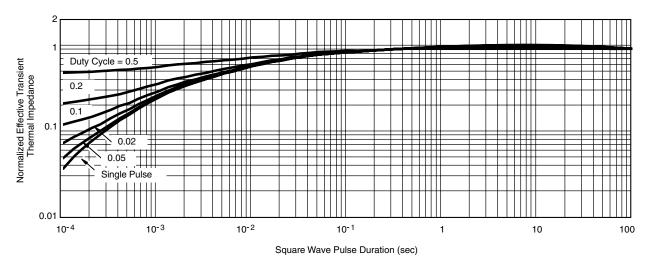
Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



### THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case

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